



OLED SPECIFICATION

Model No:

REX012864C

General Specification

The Features is described as follow:

■ Module dimension: 26.70 x 19.26 x 1.26 mm

■ Active area: 21.74 × 10.86 mm

■ Dot Matrix: 128 x 64

■ Pixel size: 0.148 × 0.148 mm

■ Pixel pitch: 0.170 × 0.170 mm

■ Display Mode: Passive Matrix

■ Duty: 1/64 Duty

Display Color: White

■ Controller IC: SH1106G

■ Interface: 6800, 8080, SPI, I2C

■ Size: 0.96 inch



Interface Pin Function

No.	Symbol	Function							
1	NC	No connection							
2	C1N	Connect to charge pump capacitor.							
3	C1P	These pins are not used and should be disconnected when Vpp is supplied externally.							
4	C2P		Connect to charge pump capacitor.						
5	C2N	These pins are not used and should be disconnected when Vpp is supplied externally.							
6	VDD2	3.0 – 4.7V power supply pad for Power supply for charge pump circuit. This pin should be disconnected when VPP is supplied externally							
7	NC	No conne	ection				,		
8	VSS	Ground.							
9	VDD1	Power su	apply input: 1	.65 - 3.5V					
10	NC	No conne	ection						
11	IM1	These ar	hese are the MPU interface mode select pads.						
	IIVI I		8080	I ² C	6800	4-wire SPI			
	IM2	IM1	1	1	0	0			
12		IM2	1	0	1	0			
13	CSB		This pad is the chip select input. When CSB = "L", then the chip select becomes active, and data/command I/O is enabled.						
14	RESB		This is a reset signal input pad. When RES is set to "L", the settings are initialized. The reset operation is performed by the RES signal level.						
15	A0	This is the Data/Command control pad that determines whether the data bits are data or a command. A0 = "H": the inputs at D0 to D7 are treated as display data. A0 = "L": the inputs at D0 to D7 are transferred to the command registers. In I2C interface, this pad serves as SA0 to distinguish the different address of OLED driver.							
This is a MPU interface input pad. When connected to an 8080 MPU, this is active LOW. the 8080 MPU WR signal. The signals on the data bus rising edge of the WR signal. When connected to a 6800 Series MPU: This is the re input terminal. When R/W = "H": Read. When R/W = "L": Write.					data bus are	latched at the			

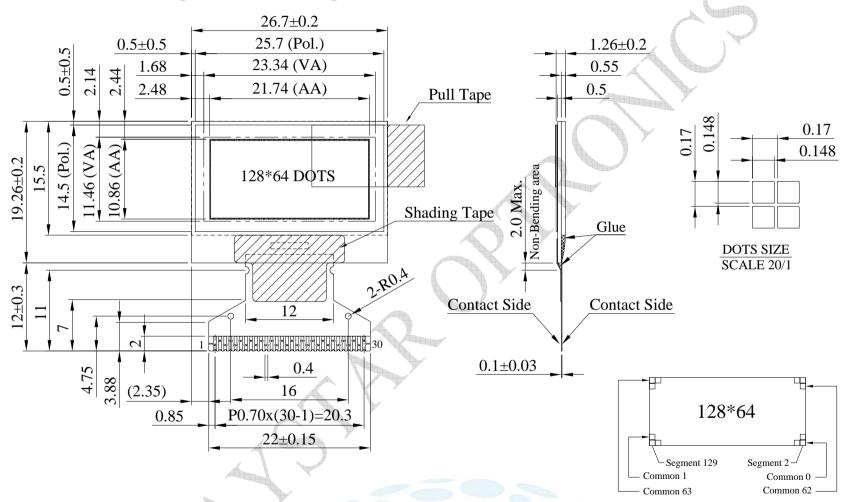


output status when this signal is "L". When connected to a 6800 series MPU, this is active HIGH. This is used as an enable clock input of the 6800 series MPU. When RD = "H": Enable. When RD = "L": Disable. This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-bit standard MPU data bus. When the serial interface is selected, then D0 serves as the serial clock input pad (SCL) and D1 serves as the serial data input pad (SI). At this time, D2 to D7 are set to high impedance. When the I2C interface is selected, then D0 serves as the serial clock input						
19 D1 standard MPU data bus. 20 D2 When the serial interface is selected, then D0 serves as the serial clock input pad (SCL) and D1 serves as the serial data input pad (SI). At this time, D2 to D7 are set to high impedance. 23 D5 When the I2C interface is selected, then D0 serves as the serial clock input pad (SCL) and D1 serves as the serial data input pad (SDAI). At this time, D2 to D7 are set to high impedance. 25 D7 to D7 are set to high impedance. 26 IREF This is a segment current reference pad. A resistor should be connected between this pad and VSS. Set the current at 18.75uA. 27 VCOMH This is a pad for the voltage output high level for common signals. A capacitor should be connected between this pad and VSS. 28 VPP OLED panel power supply. Generated by internal charge pump. Connect to capacitor. It could be supplied externally. No connection			When connected to an 8080 series MPU, it is active LOW. This pad is connected to the RD signal of the 8080 series MPU, and the data bus is in an output status when this signal is "L". When connected to a 6800 series MPU, this is active HIGH. This is used as an enable clock input of the 6800 series MPU. When RD = "H": Enable.			
D2 When the serial interface is selected, then D0 serves as the serial clock input pad (SCL) and D1 serves as the serial data input pad (SI). At this time, D2 to D7 are set to high impedance. When the I2C interface is selected, then D0 serves as the serial clock input pad (SCL) and D1 serves as the serial data input pad (SDAI). At this time, D2 to D7 are set to high impedance. IREF This is a segment current reference pad. A resistor should be connected between this pad and VSS. Set the current at 18.75uA. This is a pad for the voltage output high level for common signals. A capacitor should be connected between this pad and VSS. VPP OLED panel power supply. Generated by internal charge pump. Connect to capacitor. It could be supplied externally. No connection	\vdash		This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-bit			
 D3 pad (SCL) and D1 serves as the serial data input pad (SI). At this time, D2 to D7 are set to high impedance. D5 When the I2C interface is selected, then D0 serves as the serial clock input pad (SCL) and D1 serves as the serial data input pad (SDAI). At this time, D2 to D7 are set to high impedance. D6 IREF This is a segment current reference pad. A resistor should be connected between this pad and VSS. Set the current at 18.75uA. VCOMH VCOMH VPP OLED panel power supply. Generated by internal charge pump. Connect to capacitor. It could be supplied externally. NC No connection 			standard MPU data bus.			
D7 are set to high impedance. When the I2C interface is selected, then D0 serves as the serial clock input pad (SCL) and D1 serves as the serial data input pad (SDAI). At this time, D2 to D7 are set to high impedance. IREF This is a segment current reference pad. A resistor should be connected between this pad and VSS. Set the current at 18.75uA. This is a pad for the voltage output high level for common signals. A capacitor should be connected between this pad and VSS. VPP OLED panel power supply. Generated by internal charge pump. Connect to capacitor. It could be supplied externally. No connection	20	D2	When the serial interface is selected, then D0 serves as the serial clock input			
D5 When the I2C interface is selected, then D0 serves as the serial clock input pad (SCL) and D1 serves as the serial data input pad (SDAI). At this time, D2 to D7 are set to high impedance. REF This is a segment current reference pad. A resistor should be connected between this pad and VSS. Set the current at 18.75uA. This is a pad for the voltage output high level for common signals. A capacitor should be connected between this pad and VSS. VPP OLED panel power supply. Generated by internal charge pump. Connect to capacitor. It could be supplied externally. NC No connection	21	D3	pad (SCL) and D1 serves as the serial data input pad (SI). At this time, D2 to			
pad (SCL) and D1 serves as the serial data input pad (SDAI). At this time, D2 to D7 are set to high impedance. IREF This is a segment current reference pad. A resistor should be connected between this pad and VSS. Set the current at 18.75uA. This is a pad for the voltage output high level for common signals. A capacitor should be connected between this pad and VSS. VPP OLED panel power supply. Generated by internal charge pump. Connect to capacitor. It could be supplied externally. NC No connection	22	D4				
to D7 are set to high impedance. IREF This is a segment current reference pad. A resistor should be connected between this pad and VSS. Set the current at 18.75uA. This is a pad for the voltage output high level for common signals. A capacitor should be connected between this pad and VSS. VPP OLED panel power supply. Generated by internal charge pump. Connect to capacitor. It could be supplied externally. NC No connection	23	D5				
26 IREF This is a segment current reference pad. A resistor should be connected between this pad and VSS. Set the current at 18.75uA. 27 VCOMH This is a pad for the voltage output high level for common signals. A capacitor should be connected between this pad and VSS. 28 VPP OLED panel power supply. Generated by internal charge pump. Connect to capacitor. It could be supplied externally. 29 NC No connection	24	D6	pad (SCL) and D1 serves as the serial data input pad (SDAI). At this time, D2			
between this pad and VSS. Set the current at 18.75uA. 7 VCOMH This is a pad for the voltage output high level for common signals. A capacitor should be connected between this pad and VSS. OLED panel power supply. Generated by internal charge pump. Connect to capacitor. It could be supplied externally. No connection	25	D7	to D7 are set to high impedance.			
A capacitor should be connected between this pad and VSS. OLED panel power supply. Generated by internal charge pump. Connect to capacitor. It could be supplied externally. NC No connection	26	IREF	·			
Connect to capacitor. It could be supplied externally. No connection	27	VCOMH	A capacitor should be connected between this pad and VSS.			
	28					
30 NC No connection	29	NC	No connection			
	30	NC	No connection			





Contour Drawing & Block Diagram



PIN	SYMBOL				
1	NC				
2	C1N				
3	C1P				
4	C2P				
5	C2N VDD2				
6					
7	NC				
8	VSS				
9	VDD1				
10	NC				
11	IM1				
12	IM2				
13	CSB				
14	RESB				
15	A0				
16	WRB RDB				
17					
18	D0				
19	D1				
20	D2				
21	D3				
22	D4				
23	D5				
24	D6				
25	D7				
26	IREF				
27	VCOMH				
28	VPP				
29	NC				
30	NC				

The non-specified tolerance of dimension is ± 0.3 mm .



Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply Voltage for Logic	VDD1	-0.3	3.6	V
Power supply for charge pump circuit	VDD2	-0.3	4.8	y
Supply Voltage for Display	VPP	-0.3	14.5	V
Operating Temperature	TOP	-40	+80	°C
Storage Temperature	TSTG	-40	+85	°C

Electrical Characteristics DC Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	VDD1		2.8	3.0	3.3	٧
Power supply for charge pump circuit	VDD2	_	3.5	3.8	4.2	V
Charge Pump Output Voltage for Display (Generated by Internal DC/DC)	Charge Pump VPP	- 3	7.5	8	8.5	V
High Level Input	VIH	3-0	0.8xVDD1	2	VDD1	٧
Low Level Input	VIL		VSS	57	0.2xVDD1	V
High Level Output	VOH		0.8xVDD1	-6	VDD1	V
Low Level Output	VOL	_	VSS	_	0.2xVDD1	V
Operating Current for VDD2 Display 50% ON	IDD2	_	_	10	16	mA